

MIXIM

740MHz, Low-Noise, Low-Distortion Op Amps in SOT23-5

General Description

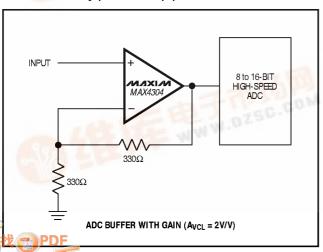
The MAX4104/MAX4105/MAX4304/MAX4305 op amps feature ultra-high speed, low noise, and low distortion in a SOT23 package. The unity-gain-stable MAX4104 requires only 20mA of supply current while delivering 625MHz bandwidth and 400V/µs slew rate. The MAX4304, compensated for gains of +2V/V or greater, delivers a 730MHz bandwidth and a 1000V/µs slew rate. The MAX4105 is compensated for a minimum gain of +5V/V and delivers a 410MHz bandwidth and a 1400V/sec slew rate. The MAX4305 has +10V/V minimum gain compensation and delivers a 340MHz bandwidth and a 1400V/µs slew rate.

Low voltage noise density of 2.1nV/√Hz and -88dBc spurious-free dynamic range make these devices ideal for low-noise/low-distortion video and telecommunications applications. These op amps also feature a wide output voltage swing of ±3.7V and ±70mA output currentdrive capability. For space-critical applications, they are available in a miniature 5-pin SOT23 package.

Applications

Video ADC Preamp Pulse/RF Telecom Applications Video Buffers and Cable Drivers Ultrasound Active Filters **ADC Input Buffers**

Typical Application Circuit



Features

- ◆ Low 2.1nV/√Hz Voltage Noise Density
- ◆ Ultra-High 740MHz -3dB Bandwidth (MAX4304, Avcl = 2V/V
- ♦ 100MHz 0.1dB Gain Flatness (MAX4104/4105)
- 1400V/μs Slew Rate (MAX4105/4305)
- ♦ -88dBc SFDR (5MHz, R_L = 100Ω) (MAX4104/4304)
- High Output Current Drive: ±70mA
- ♦ Low Differential Gain/Phase Error: 0.01%/0.01° (MAX4104/4304)
- ◆ Low ±1mV Input Offset Voltage
- Available in Space-Saving 5-Pin SOT23 Package

Selector Guide

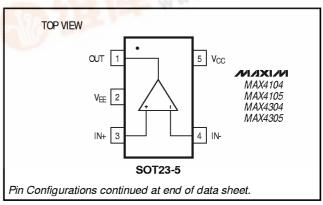
PART	MINIMUM STABLE GAIN (V/V)	BANDWIDTH (MHz)	PIN-PACKAGE
MAX4104	1	625	5-pin SOT23, 8-pin SO
MAX4304	2	740	5-pin SOT23, 8-pin SO
MAX4105	5	410	5-pin SOT23, 8-pin SO
MAX4305	10	340	5-pin SOT23, 8-pin SO

Ordering Information

PART	TEMP. RANGE	PIN- PACKAGE	SOT TOP MARK	
MAX4104ESA	-40℃ to +85℃	8 SO	_	
MAX4104EUK-T	-40°C to +85°C	5 SOT23-5	ACCO	

Ordering Information continued at end of data sheet.

Pin Configurations



Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

 Operating Temperature Range40 $^{\circ}$ C to +85 $^{\circ}$ C Storage Temperature Range65 $^{\circ}$ C to +150 $^{\circ}$ C Lead Temperature (soldering, 10sec)+300 $^{\circ}$ C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +5V, V_{EE} = -5V, V_{CM} = 0, R_L = 100k\Omega, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25$ °C.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Supply Voltage Range	V _{CC} /V _{EE}	Guaranteed by PSRR test		±3.5	±5	±5.5	V
Innuit Officet Voltage	Vaa		MAX4_0_ESA		1	6	mV
Input Offset Voltage	Vos	V _{OUT} = 0	MAX4_0_EUK		1	8	
Input Offset-Voltage Drift	TCVOS		•		2.5		μV/℃
Input Bias Current	lΒ				32	70	μΑ
Input Offset Current	los				0.5	5.0	μΑ
Differential Input Resistance	RiN	-0.8V ≤ V _{IN} ≤ 0.8V			6		kΩ
Common-Mode Input Resistance	R _{IN}	Either input			1.5		ΜΩ
Input Common-Mode Voltage Range	Vсм	Guaranteed by CMRR test				+4.1	V
Common-Mode Rejection Ratio	CMRR	-2.8V ≤ V _{CM} ≤ 4.1V	80	95		dB	
Positive Power-Supply Rejection Ratio	PSSR+	V _{CC} = 3.5V to 5.5V		75	85		dB
Negative Power-Supply Rejection Ratio	PSRR-	V _{EE} = -3.5V to -5.5V		55	65		dB
Quiescent Supply Current	Is	V _{OUT} = 0			20	27	mA
Open-Loop Gain	Avol	$-2.8V \le V_{OUT} \le 2.8V, R_L = 100\Omega$		55	65		dB
Outros Vallaga Caira	Vour	$R_L = 100k\Omega$		±3.5	-3.7 to +3.8	3	V
Output Voltage Swing	Vout	$R_L = 100\Omega$		±3.0 -3.5 to +3.4			'
Output Current Drive	lout	$R_L = 30\Omega$		±53	±70		mA
Short-Circuit Output Current	Isc	R _L = short to ground			80		mA
Open-Loop Output Impedance	Z _{OUT}				9		Ω





AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +5V, V_{EE} = -5V, V_{CM} = 0, R_L = 100\Omega; A_V = +1V/V \text{ for MAX4104}, +2V/V \text{ for MAX4304}, +5V/V \text{ for MAX4105}, +10V/V \text{ for MAX4305}; T_A = +25°C; unless otherwise noted.)$

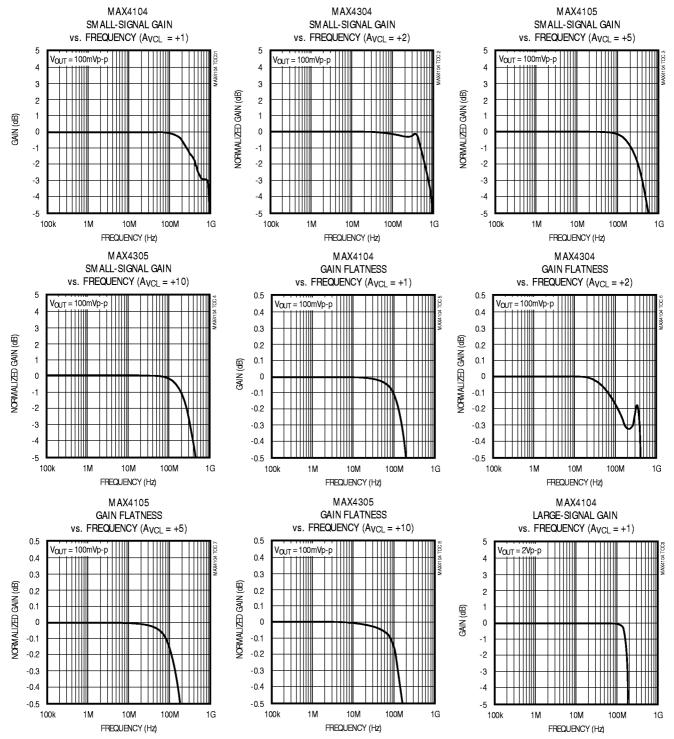
PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS		
		V _{OUT} = 100mVp-p		MAX4104		625		- MHz		
-3dB Bandwidth	DW(MAX4304		740				
	BW _(-3dB)			MAX4105		410				
				MAX4305		340				
		V _{OUT} = 100mVp-p		MAX4104		100		- MHz		
0.1dB Bandwidth	DM/			MAX4304		60				
0.10B Barlowidtri	BW _(0.1)			MAX4105		80				
				MAX4305		70				
		V _{OUT} = 2Vp-p		MAX4104		115				
Full-Power Bandwidth	FPBW			MAX4304		285		- MHz		
Full-Fower Bandwidth	FFBVV			MAX4105		370				
				MAX4305		320				
		V _{OUT} = 2Vp-p		MAX4104		400		- V/μs		
Slew Rate	SR			MAX4304		1000				
Siew hate) on			MAX4105		1400				
				MAX4305		1400				
Settling Time to 0.1%	to	V _{OUT} = 2Vp-p			to 0.1%		20		ne	
Settling Time to 0.1%	ts			to 0.01%		25		ns		
		V _{OUT} = 2Vp-p	MAX4	104/	f _C = 5MHz		-88		dBc	
Spurious-Free	SFDR		MAX4	304	f _C = 20MHz		-67			
Dynamic Range	SEDIN		MAX4	105/	f _C = 5MHz		-74		ubc	
			MAX4	305	f _C = 20MHz		-61		1	
Differential Gain Error	DG	NTCC D: 1	MAX4		4104/MAX4304		0.01		%	
	DG	NTSC, $R_L = 150\Omega$		MAX4105/MAX4305			0.02		70	
Differential Phase Error	DP	NTSC. Ri = 150Ω		4104/MAX4304		0.01		dograce		
Dillerential Phase Error	DP			4105/MAX4305		0.02		degrees		
Input Voltage Noise Density	en	f = 1MHz				2.1		nV/√Hz		
Input Current Noise Density	in	f = 1MHz				3.1		p A /√Hz		
Output Impedance	Z _{OUT}	f = 10MHz				1		Ω		



as per as an

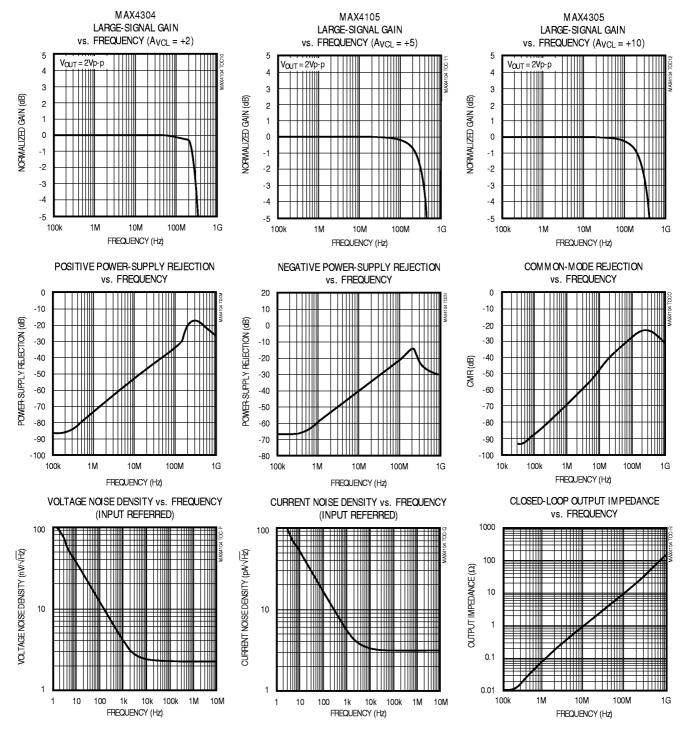
_Typical Operating Characteristics

(V_{CC} = +5V, V_{EE} = -5V, R_F = 330 Ω , R_L = 100 Ω , T_A = +25 °C, unless otherwise noted.)



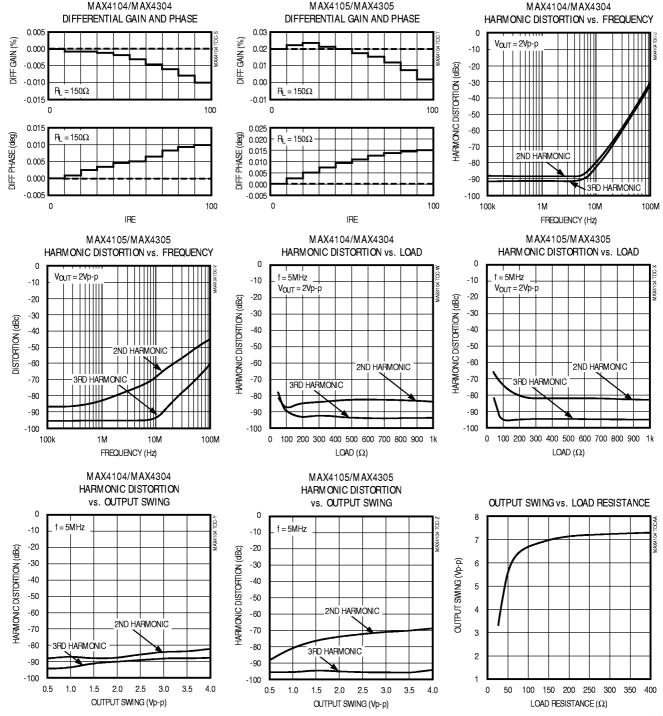
_Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = -5V, R_F = 330\Omega, R_L = 100\Omega, T_A = +25 \,^{\circ}C$, unless otherwise noted.)



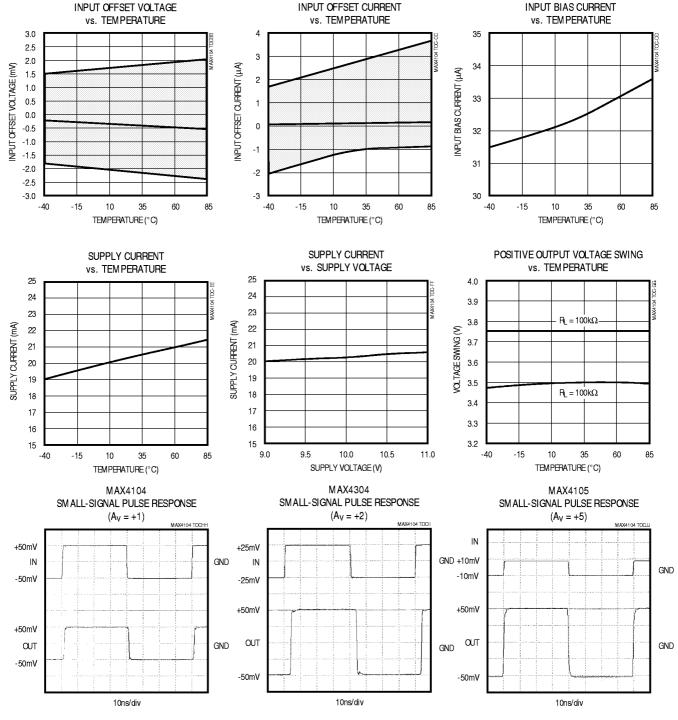
_____Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = -5V, R_F = 330\Omega, R_L = 100\Omega, T_A = +25$ °C, unless otherwise noted.)



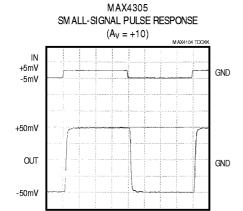
_Typical Operating Characteristics (continued)

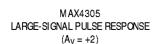
 $(V_{CC} = +5V, V_{EE} = -5V, R_F = 330\Omega, R_L = 100\Omega, T_A = +25$ °C, unless otherwise noted.)



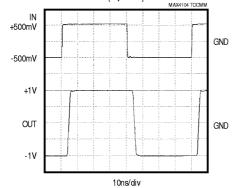
_Typical Operating Characteristics (continued)

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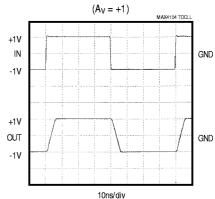




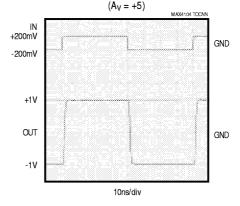
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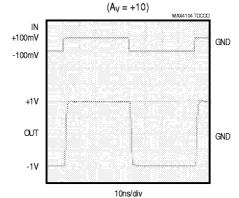
M AX4104 LARGE-SIGNAL PULSE RESPONSE



MAX4105 LARGE-SIGNAL PULSE RESPONSE



MAX4305 LARGE-SIGNAL PULSE RESPONSE



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Pin Description

PIN		NAME	FUNCTION		
SOT23-5	so	IVAIVIE	FUNCTION		
_	1, 5, 8	N.C.	Not internally connected.		
4	2	IN-	Amplifier Inverting Input		
3	3	IN+	Amplifier Noninverting Input		
2	4	VEE	Negative Power Supply		
1	6	OUT	Amplifier Output		
5	7	Vcc	Positive Power Supply		

_Detailed Description

The MAX4104/MAX4105/MAX4304/MAX4305 are ultrahigh-speed, low-noise amplifiers featuring -3dB bandwidths up to 880MHz, 0.1dB gain flatness up to 100MHz, and low differential gain and phase errors of 0.01% and 0.01°, respectively. These devices operate on dual power supplies ranging from $\pm 3.5 \text{V}$ to $\pm 5.5 \text{V}$ and require only 20mA of supply current.

The MAX4104/MAX4304/MAX4105/MAX4305 are optimized for minimum closed-loop gains of +1V/V, +2V/V, +5V/V and +10V/V (respectively) with corresponding -3dB bandwidths of 880MHz, 730MHz, 430MHz, and 350MHz. Each device in this family features a low input voltage noise density of only 2.1nV/ $\sqrt{\text{Hz}}$ (at 1MHz), an output current drive of ± 70 mA, and spurious-free dynamic range as low as -88dBc (5MHz, RL = 100 Ω).

_Applications Information

Layout and Power-Supply Bypassing
The MAX4104/MAX4105/MAX4304/MAX4305 have an
extremely high bandwidth, and consequently require
careful board layout, including the possible use of

To realize the full AC performance of these high-speed amplifiers, pay careful attention to power-supply bypassing and board layout. The PC board should have at least two layers: a signal and power layer on one side, and a large, low-impedance ground plane on the other side. The ground plane should be as free of voids as possible. With multilayer boards, locate the ground plane on a layer that incorporates no signal or power traces.

constant-impedance microstrip or stripline techniques.

Regardless of whether or not a constant-impedance board is used, it is best to observe the following guidelines when designing the board:

- Do not use wire-wrapped boards (they are much too inductive) or breadboards (they are much too capacitive).
- Do not use IC sockets. IC sockets increase reactances.
- Keep signal lines as short and straight as possible.
 Do not make 90° turns; round all corners.
- Observe high-frequency bypassing techniques to maintain the amplifier's accuracy and stability.
- 5) Bear in mind that, in general, surface-mount components have shorter bodies and lower parasitic reactance, resulting in greatly improved high-frequency performance over through-hole components.

The bypass capacitors should include 1nF and $0.1\mu F$ ceramic surface-mount capacitors between each supply pin and the ground plane, located as close to the package as possible. Optionally, place a $10\mu F$ tantalum capacitor at the power supply pins' point of entry to the PC board to ensure the integrity of incoming supplies. The power-supply trace should lead directly from the tantalum capacitor to the VCC and VEE pins. To minimize parasitic inductance, keep PC traces short and use surface-mount components.

Input termination resistors and output back-termination resistors, if used, should be surface-mount types, and should be placed as close to the IC pins as possible.

DC and Noise Errors

The MAX4104/MAX4105/MAX4304/MAX4305 output offset voltage, V_{OUT} (Figure 1), can be calculated with the following equation:

Vout = [Vos + (I_{B+} x R_S) + (I_{B-} x (R_F \parallel R_G))] [1 + R_F / R_G] where:

Vos = input offset voltage (in volts)

1 + RF/RG = amplifier closed-loop gain (dimensionless)

IB+ = noninverting input bias current (in amps)

IB- = inverting input bias current (in amps)

R_G = gain-setting resistor (in ohms)

RF = feedback resistor (in ohms)

Rs = source resistor at noninverting input (in ohms)

The following equation represents output noise density:

$$e_{n(OUT)} = \left[1 + \frac{R_F}{R_G}\right] \sqrt{\left(i_n \times R_S\right)^2 + \left[i_n \times \left(R_F \mid\mid R_G\right)\right]^2 + e_n^2}$$



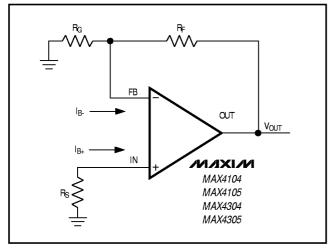


Figure 1. Output Offset Voltage

where:

 i_n = input current noise density (in pA/ \sqrt{Hz}) e_n = input voltage noise density (in nV/ \sqrt{Hz})

The MAX4104/MAX4105/MAX4304/MAX4305 have a very low, $2.1 \text{nV}/\sqrt{\text{Hz}}$ input voltage noise density and $3.1 \text{pA}/\sqrt{\text{Hz}}$ input current noise density.

An example of DC-error calculations, using the MAX4304 typical data and the typical operating circuit with RF = RG = 330Ω (RF \parallel RG = 165Ω) and RS = 50Ω gives:

$$\begin{split} V_{OUT} &= \left[\left(32 \times 10^{-6} \right) \left(50 \right) + \left(32 \times 10^{-6} \right) \left(165 \Omega \right) + 1 \times 10^{-3} \right] \left[1 \ + \ 1 \right] \\ V_{OUT} &= \ 15.8 \text{mV} \end{split}$$

Calculating total output noise in a similar manner yields the following:

$$\begin{split} e_{n(OUT)} &= \\ \left[1+1\right] \sqrt{\left(3.1 \times 10^{-12} \times 50\right)^2 + \left(3.1 \times 10^{-12} \times 165\right)^2 + \left(2.1 \times 10^{-9}\right)^2} \\ e_{n(OUT)} &= 4.3 \text{nV} \sqrt{\text{Hz}} \end{split}$$

With a 200MHz system bandwidth, this calculates to $60.8\mu V_{RMS}$ (approximately $365\mu V_{P-P}$, using the six-sigma calculation).

ADC Input Buffers

Input buffer amplifiers can be a source of significant error in high-speed ADC applications. The input buffer is usually required to rapidly charge and discharge the ADC's input, which is often capacitive. In addition, the input impedance of a high-speed ADC often changes

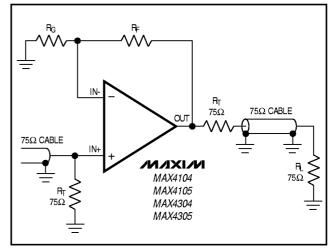


Figure 2. Video Line Driver

very rapidly during the conversion cycle—a condition that demands an amplifier with very low output impedance at high frequencies to maintain measurement accuracy. The combination of high-speed, fast slew rate, low noise, and low-distortion available in the MAX4104/MAX4105/MAX4304/MAX4305 makes them ideally suited for use as buffer amplifiers in high-speed ADC applications.

Video Line Driver

The MAX4104/MAX4105/MAX4304/MAX4305 are optimized to drive coaxial transmission lines when the cable is terminated at both ends, as shown in Figure 2. To minimize reflections and maximize power transfer, select the termination resistors to match the characteristic impedance of the transmission line. Cable frequency response can cause variations in the flatness of the signal.

Driving Capacitive Loads

The MAX4104/MAX4105/MAX4304/MAX4305 provide maximum AC performance when driving no output load capacitance. This is the case when driving a correctly terminated transmission line (i.e., a back-terminated cable).

In most amplifier circuits, driving a large load capacitance increases the chance of oscillations occurring. The amplifier's output impedance and the load capacitor combine to add a pole and excess phase to the loop response. If the pole's frequency is low enough and phase margin is degraded sufficiently, oscillations may result.

A second concern when driving capacitive loads originates from the amplifier's output impedance, which

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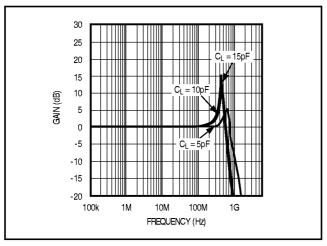


Figure 3a. MAX4104 Frequency Response with Capacitive Load and No Isolation Resistor

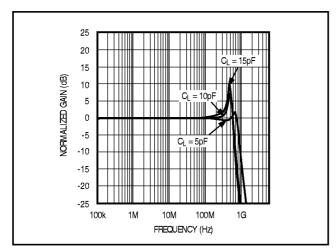
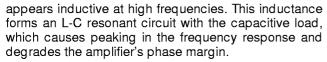


Figure 3c. MAX4105 Frequency Response with Capacitive Load and No Isolation Resistor



The MAX4104/MAX4105/MAX4304/MAX4305 drive capacitive loads up to 10pF without oscillation. However, some peaking may occur in the frequency domain (Figure 3). To drive larger capacitance loads or to reduce ringing, add an isolation resistor between the amplifier's output and the load (Figure 4).

The value of R_{ISO} depends on the circuit's gain and the capacitive load (Figure 5). Figure 6 shows the MAX4104/MAX4105/MAX4304/MAX4305 frequency response with the isolation resistor and a capacitive

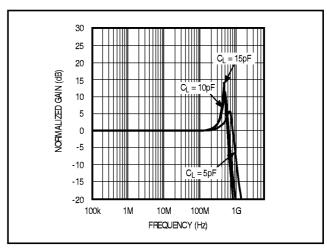


Figure 3b. MAX4304 Frequency Response with Capacitive Load and No Isolation Resistor

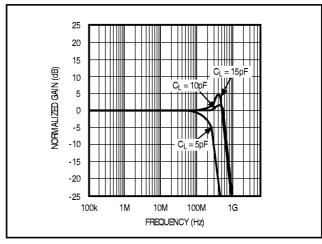


Figure 3d. MAX4305 Frequency Response with Capacitive Load and No Isolation Resistor

load. With higher capacitive values, bandwidth is dominated by the RC network formed by $R_{\rm ISO}$ and $C_{\rm L}$; the bandwidth of the amplifier itself is much higher. Also note that the isolation resistor forms a divider that decreases the voltage delivered to the load.

Maxim's High-Speed Evaluation Boards The MAX4104 evaluation kit manual shows a suggested layout for Maxim's high-speed, single-amplifier evaluation boards. This board was developed using the techniques described previously (see Layout and Power-Supply Bypassing section). The smallest available surface-mount resistors were used for the feedback and back-termination resistors to minimize the



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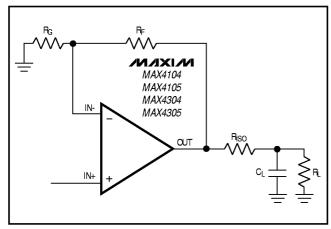


Figure 4. Using an Isolation Resistor (R_{ISO}) for High Capacitive Loads

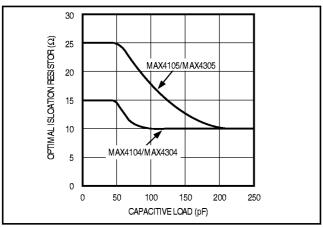
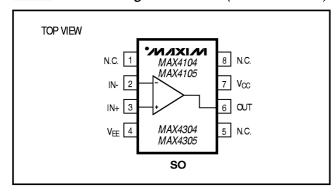


Figure 5. Optimal Isolation Resistor (R_{ISO}) vs. Capacitive

___Pin Configurations (continued)



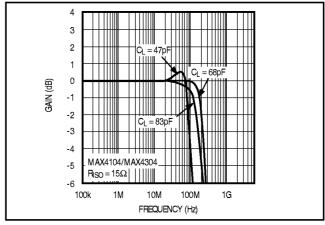


Figure 6. Frequency Responses vs. Capacitive Load with 15 Ω Isolation Resistor

distance from the IC to these resistors, thus reducing the capacitance associated with longer lead lengths.

SMA connectors were used for best high-frequency performance. Because distances are extremely short, performance is unaffected by the fact that inputs and outputs do not match a 50Ω line. However, in applications that require lead lengths greater than 1/4 of the wavelength of the highest frequency of interest, constant-impedance traces should be used.

Fully assembled evaluation boards are available for the MAX4104 in an 8-pin SO package.

_Ordering Information (continued)

PART	TEMP. RANGE	PIN- PACKAGE	SOT TOP MARK	
MAX4105ESA	-40℃ to +85℃	8 SO	_	
MAX4105EUK-T	-40°C to +85°C	5 SOT23-5	ACCP	
MAX4304ESA	-40°C to +85°C	8 SO	_	
MAX4304EUK-T	-40°C to +85°C	5 SOT23-5	ACCQ	
MAX4305ESA*	-40℃ to +85℃	8 SO	_	
MAX4305EUK-T	-40°C to +85°C	5 SOT23-5	ACCR	

^{*}Future product—contact factory for availability.

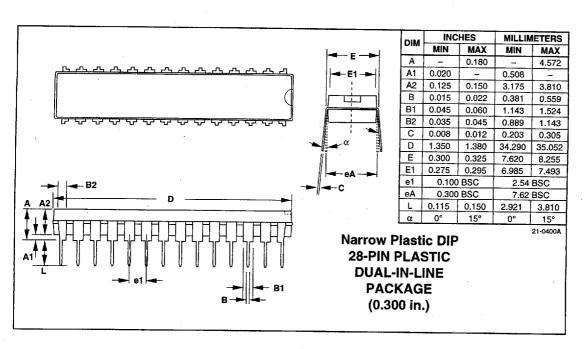
Chip Information

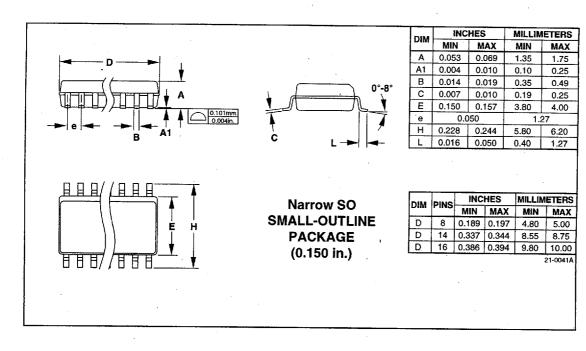
TRANSISTOR COUNT: 44

SUBSTRATE CONNECTED TO VEE

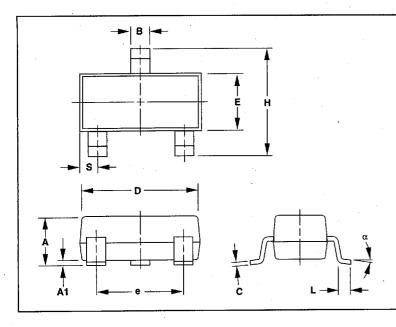
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Package Information





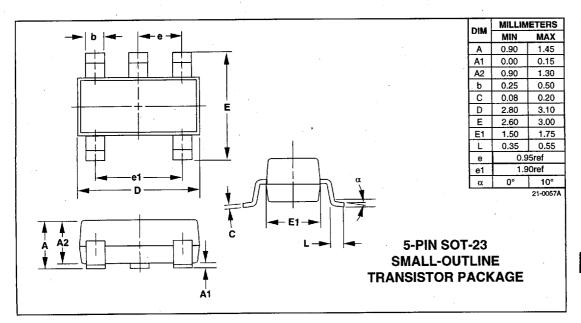
_Package Information



DIM	INC	HES	MILLIMETERS		
DIM	MIN	MIN MAX		MAX	
Α	0.031	0.047	0.787	1.194	
A1	0.001	0.005	0.025	0.127	
В	0.014	0.022	0.356	0.559	
C	0.0034	0.006	0.086	0.152	
D	0.105	0.120	2.667	3.048	
Е	0.047	0.055	1.194	1.397	
е	0.070	0.080	1.778	2.032	
Н	0.082	0.098	2.083	2.489	
L	0.004	0.012	0.102	0.305	
S	0.017	0.022	0.432	0.559	
α	. 0,	8*	0,	8.	

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3-PIN SOT-23 SMALL-OUTLINE TRANSISTOR PACKAGE



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